

Single Low Noise Operational Amplifier

NE5534, SA5534, SE5534, NE5534A, SA5534A, SE5534A

The NE/SA/SE5534/5534A are single high-performance low noise operational amplifiers. Compared to other operational amplifiers, such as TL083, they show better noise performance, improved output drive capability, and considerably higher small-signal and power bandwidths.

This makes the devices especially suitable for application in high quality and professional audio equipment, in instrumentation and control circuits and telephone channel amplifiers. The op amps are internally compensated for gain equal to, or higher than, three. The frequency response can be optimized with an external compensation capacitor for various applications (unity gain amplifier, capacitive load, slew rate, low overshoot, etc.).

Features

• Small-Signal Bandwidth: 10 MHz

• Output Drive Capability: 600 Ω , 10 V_{RMS} at V_S = \pm 18 V

Input Noise Voltage: 4 nV/√Hz

• DC Voltage Gain: 100000

• AC Voltage Gain: 6000 at 10 kHz

• Power Bandwidth: 200 kHz

• Slew Rate: 13 V/μs

• Large Supply Voltage Range: ± 3.0 to ± 20 V

• Pb-Free Packages are Available

Applications

- Audio Equipment
- Instrumentation and Control Circuits
- Telephone Channel Amplifiers
- Medical Equipment

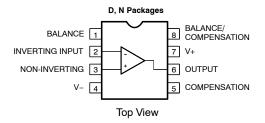


SOIC-8 D SUFFIX CASE 751-07



PDIP-8 N SUFFIX CASE 626-05

PIN CONNECTIONS



DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 8 of this data sheet.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 8.

1

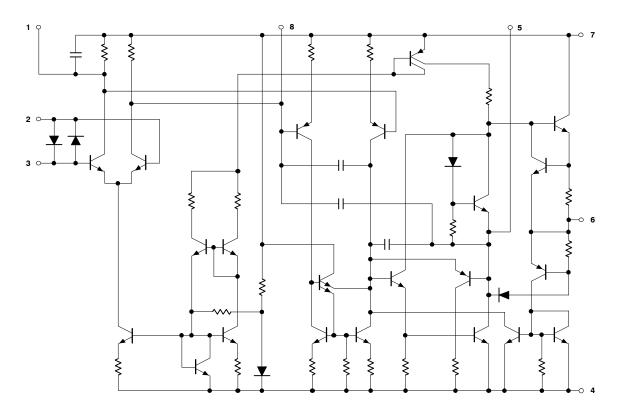


Figure 1. Equivalent Schematic

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	V _S	± 22	V
Input Voltage	V _{IN}	± V Supply	V
Differential Input Voltage (Note 1)	V _{DIFF}	±0.5	V
Operating Temperature Range NE SA SE	T _{amb}	0 to +70 -40 to +85 -55 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Junction Temperature	Tj	150	°C
Power Dissipation at 25°C N Package D Package	P _D	1150 750	mW
Thermal Resistance, Junction-to-Ambient N Package D Package	$R_{ heta JA}$	130 158	°C/W
Output Short-Circuit Duration (Note 2)	-	Indefinite	-
Lead Soldering Temperature (10 sec max)	T _{sld}	230	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Diodes protect the inputs against overvoltage. Therefore, unless current-limiting resistors are used, large currents will flow if the differential input voltage exceeds 0.6 V. Maximum current should be limited to \pm 10 mA.
- 2. Output may be shorted to ground at $V_S = \pm 15$ V, $T_{amb} = 25$ °C. Temperature and/or supply voltages must be limited to ensure dissipation rating is not exceeded.

DC ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$; $V_{S} = \pm 15 \text{ V}$, unless otherwise noted.) (Notes 3, 4 and 5)

			NE/SA5534/5534A		SE5534/5534A				
Characteristic	Symbol	Test Conditions	Min	Тур	Max	Min	Тур	Max	Unit
	Vos		_	0.5	4.0	-	0.5	2.0	mV
Offset Voltage		Overtemperature	_	-	5.0	-	-	3.0	mV
	$\Delta V_{OS}/\Delta T$		_	5.0	_	-	5.0	-	μV/°C
	Ios		_	20	300	-	10	200	nA
Offset Current		Overtemperature	-	-	400	-	-	500	nA
	$\Delta I_{OS}/\Delta T$		-	200	_	-	200	-	pA/°C
	Ι _Β		_	500	1500	_	400	800	nA
Input Current		Overtemperature	_	_	2000	-	-	1500	nA
	$\Delta I_B/\Delta T$		_	5.0	_	-	5.0	-	nA/°C
Supply Current Per Op Amp	I _{CC}	Overtemperature	-	4.0 -	8.0 10	-	4.0 -	6.5 9.0	mA
Common Mode Input Range Common Mode Rejection Ratio Power Supply Rejection Ratio	V _{CM} CMRR PSRR		±12 70 -	±13 100 10	- - 100	±12 80 -	±13 100 10	- - 50	V dB μV/V
Large-Signal Voltage Gain	A _{VOL}	$R_L \ge 600 \Omega$,	25	100	_	50	100	-	V/mV
		$V_0 = \pm 10 \text{ V}$ Overtemperature	15	-	-	25	-	-	
Output Swing	V _{OUT}	$R_L \ge 600 \Omega$	±12	±13	_	±12	±13	_	V
		Overtemperature	±10	±12	_	±10	±12	-	
		$R_L \ge 600 \Omega;$ $V_S = \pm 18 V$	±15	±16	_	±15	16	_	
		$R_L \ge 2.0 \text{ k}\Omega$	±13	±13.5	_	±13	± 13.5	-	
		Overtemperature	±12	±12.5	_	±12	± 12.5	-	
Input Resistance	R _{IN}		30	100	_	50	100	1	kΩ
Output Short Circuit Current	I _{SC}		-	38	-	-	38	-	mA

^{3.} For NE5534/5534A, T_{MIN} = 0°C, T_{MAX} = 70°C. 4. For SA5534/5534A, T_{MIN} = -40°C, T_{MAX} = +85°C. 5. For SE5534/5534A, T_{MIN} = -55°C, T_{MAX} = +125°C.

AC ELECTRICAL CHARACTERISTICS (T_{amb} = 25°C; V_S = \pm 15 V, unless otherwise noted.)

			NE/S	SA5534/55	534A	SI	E5534/553	4A	
Characteristic	Symbol	Test Conditions	Min	Тур	Max	Min	Тур	Max	Unit
Output Resistance	R _{OUT}	$\begin{aligned} A_V &= 30 \text{ dB} \\ \text{closed-loop} \\ f &= 10 \text{ kHz}; \\ R_L &= 600 \ \Omega; \\ C_C &= 22 \text{ pF} \end{aligned}$	-	0.3	-	-	0.3	-	Ω
Transient Response		$\label{eq:Voltage-follower} \begin{split} & \text{Voltage-follower,} \\ & \text{V}_{\text{IN}} = 50 \text{ mV} \\ & \text{R}_{\text{L}} = 600 \ \Omega, \\ & \text{C}_{\text{C}} = 22 \text{ pF,} \\ & \text{C}_{\text{L}} = 100 \text{ pF} \end{split}$							
Rise Time	t _R		_	20	-	_	20	_	ns
Overshoot	-		_	20	-	-	20	-	%
Transient Response		$V_{IN} = 50 \text{ mV},$ $R_L = 600 \Omega,$ $C_C = 47 \text{ pF},$ $C_L = 500 \text{ pF}$							
Rise Time	t _R		_	50	-	_	50	_	ns
Overshoot	-		_	35	-	-	35	_	%
Gain	A _V	f = 10 kHz, C _C = 0	-	6.0	-	-	6.0	_	V/mV
		f = 10 kHz, C _C = 22 pF	-	2.2	_	-	2.2	_	
Gain Bandwidth Product	GBW	C _C = 22 pF, C _L = 100 pF	-	10	-	-	10	-	MHz
Slew Rate	SR	C _C = 0	-	13	-	-	13	-	V/μs
		C _C = 22 pF	_	6.0	-	_	6.0	-	
Power Bandwidth	_	$V_{OUT} = \pm 10 \text{ V},$ $C_C = 0 \text{ pF}$	-	200	_	-	200	_	kHz
		$V_{OUT} = \pm 10 \text{ V},$ $C_C = 22 \text{ pF}$	-	95	_	-	95	_	
		$V_{OUT} = \pm 14 \text{ V}, \\ R_L = 600 \ \Omega, \\ C_C = 22 \text{ pF}, \\ V_{CC} = \pm 18 \text{ V}$	_	70	_	_	70	_	

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25^{\circ}C$; $V_{S} = 15 \text{ V}$, unless otherwise noted.)

			NE	SA/SE55	i34	NE,	/SA/SE55	34A	
Characteristic	Symbol	Test Conditions	Min	Тур	Max	Min	Тур	Max	Unit
Input Noise Voltage	V _{NOISE}	f _O = 30 Hz f _O = 1.0 kHz	- -	7.0 4.0	-	-	5.5 3.5	7.0 4.5	nV/√Hz
Input Noise Current	I _{NOISE}	f _O = 30 Hz f _O = 1.0 kHz	- -	2.5 0.6	-	-	1.5 0.4	- -	pA/√Hz
Broadband Noise Figure	-	f = 10 Hz to 20 kHz; R_S = 5.0 kΩ	-	-	-	-	0.9	-	dB
Channel Separation	-	f = 1.0 kHz; R_S = 5.0 kΩ	_	110	_	-	110	-	dB

TYPICAL PERFORMANCE CHARACTERISTICS

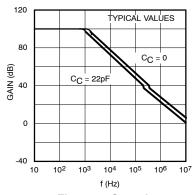


Figure 2. Open-Loop Frequency Response

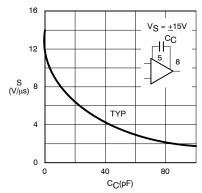


Figure 3. Slew Rate as a Function of Compensation Capacitance

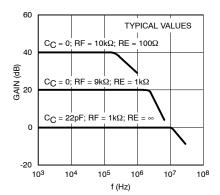


Figure 4. Closed-Loop Frequency Response

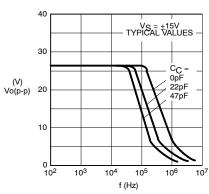


Figure 5. Large-Signal Frequency Response

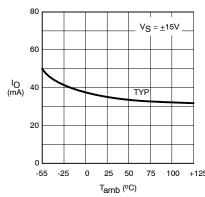


Figure 6. Output Short-Circuit Current

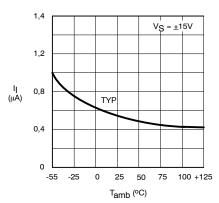


Figure 7. Input Bias Current

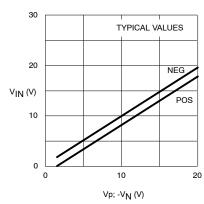


Figure 8. Input Common-Mode Voltage Range

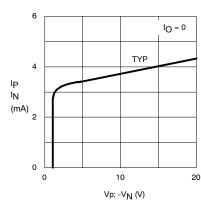


Figure 9. Supply Current Per Op Amp

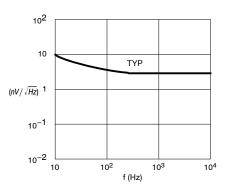


Figure 10. Input Noise Voltage Density

TYPICAL PERFORMANCE CHARACTERISTICS

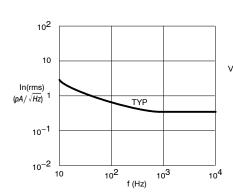


Figure 11. Input Noise Current Density

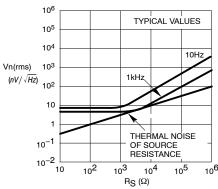


Figure 12. Total Input Noise Density

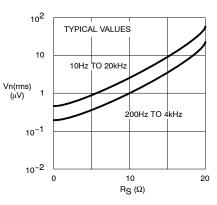


Figure 13. Broadband Input Noise Voltage

TEST LOAD CIRCUITS

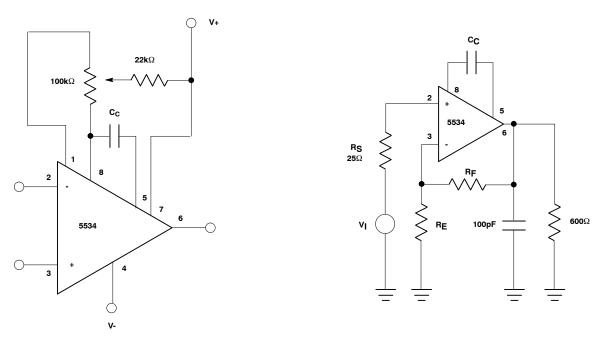


Figure 14. Frequency Compensation and Offset Voltage Adjustment Circuit

Figure 15. Closed-Loop Frequency Response

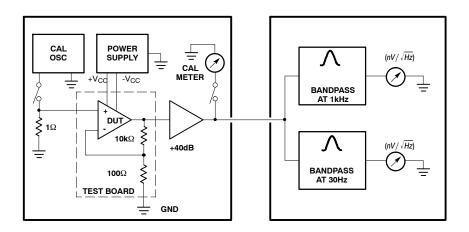


Figure 16. Noise Test Block Diagram

MARKING DIAGRAMS













SOIC-8 D SUFFIX CASE 751 PDIP-8 N SUFFIX CASE 626

 $egin{array}{lll} x & = Blank \ or \ A & = Assembly \ Location \ WL, \ L & = Wafer \ Lot \ \end{array}$

YY, Y = Year WW, W = Work Week G or ■ = Pb-Free Package

ORDERING INFORMATION

Device	Description	Temperature Range	Shipping [†]
SA5534ADR2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	−40 to +85°C	2500 / Tape & Reel

DISCONTINUED (Note 6)

	1		
NE5534AD	8-Pin Plastic Small Outline (SO-8) Package	0 to +70°C	98 Units / Rail
NE5534ADG	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	0 to +70°C	98 Units / Rail
NE5534ADR2	8-Pin Plastic Small Outline (SO-8) Package	0 to +70°C	2500 / Tape & Reel
NE5534ADR2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	0 to +70°C	2500 / Tape & Reel
NE5534AN	8-Pin Plastic Dual In-Line Package (PDIP-8)	0 to +70°C	50 Units / Rail
NE5534ANG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	0 to +70°C	50 Units / Rail
NE5534D	8-Pin Plastic Small Outline (SO-8) Package	0 to +70°C	98 Units / Rail
NE5534DG	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	0 to +70°C	98 Units / Rail
NE5534DR2	8-Pin Plastic Small Outline (SO-8) Package	0 to +70°C	2500 / Tape & Reel
NE5534DR2G	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	0 to +70°C	2500 / Tape & Reel
NE5534N	8-Pin Plastic Dual In-Line Package (PDIP-8)	0 to +70°C	50 Units / Rail
NE5534NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	0 to +70°C	50 Units / Rail
SA5534AD	8-Pin Plastic Small Outline (SO-8) Package	−40 to +85°C	98 Units / Rail
SA5534ADG	8-Pin Plastic Small Outline (SO-8) Package (Pb-Free)	−40 to +85°C	98 Units / Rail
SA5534ADR2	8-Pin Plastic Small Outline (SO-8) Package	−40 to +85°C	2500 / Tape & Reel
SA5534AN	8-Pin Plastic Dual In-Line Package (PDIP-8)	−40 to +85°C	50 Units / Rail
SA5534ANG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	−40 to +85°C	50 Units / Rail
SA5534N	8-Pin Plastic Dual In-Line Package (PDIP-8)	−40 to +85°C	50 Units / Rail
SA5534NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	−40 to +85°C	50 Units / Rail
SE5534AN	8-Pin Plastic Dual In-Line Package (PDIP-8)	−55 to +125°C	50 Units / Rail
SE5534ANG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	−55 to +125°C	50 Units / Rail
SE5534N	8-Pin Plastic Dual In-Line Package (PDIP-8)	−55 to +125°C	50 Units / Rail
SE5534NG	8-Pin Plastic Dual In-Line Package (PDIP-8) (Pb-Free)	−55 to +125°C	50 Units / Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

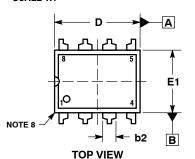
^{6.} **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

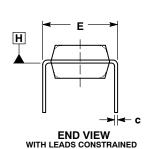




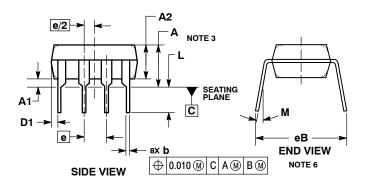
PDIP-8 CASE 626-05 **ISSUE P**

DATE 22 APR 2015





NOTE 5



STYLE 1: PIN 1. AC IN 2. DC + IN 3. DC - IN 4. AC IN

5. GROUND 6. OUTPUT

7. AUXILIARY 8. V_{CC}

NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCHES.
 DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACK-
- AGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
 DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
- DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
- 6. DIMENSION eB IS MEASURED AT THE LEAD TIPS WITH THE
- DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
- 8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α		0.210		5.33
A1	0.015		0.38	
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060	TYP	1.52 TYP	
С	0.008	0.014	0.20	0.36
D	0.355	0.400	9.02	10.16
D1	0.005		0.13	
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
е	0.100	BSC	2.54	BSC
eB		0.430		10.92
L	0.115	0.150	2.92	3.81
М		10°		10°

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code = Assembly Location WL = Wafer Lot

YY = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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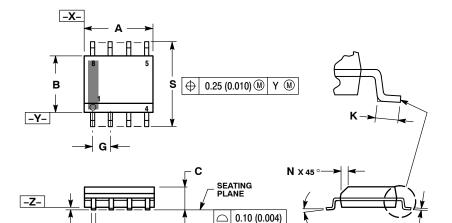
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SOIC-8 NB CASE 751-07 **ISSUE AK**

DATE 16 FEB 2011



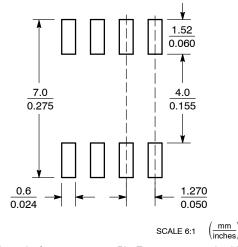
XS

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

	MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
J	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
М	0 °	8 °	0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

SOLDERING FOOTPRINT*

0.25 (0.010) M Z Y S



^{*}For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location = Wafer Lot

= Year = Work Week W = Pb-Free Package

XXXXXX XXXXXX AYWW AYWW H \mathbb{H} Discrete **Discrete** (Pb-Free)

XXXXXX = Specific Device Code = Assembly Location Α

ww = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

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DESCRIPTION:	SOIC-8 NB		PAGE 1 OF 2			

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DATE 16 FEB 2011

STYLE 1: PIN 1. EMITTER 2. COLLECTOR 3. COLLECTOR 4. EMITTER 5. EMITTER 6. BASE 7. BASE 8. EMITTER	STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 3. COLLECTOR, #2 4. COLLECTOR, #2 5. BASE, #2 6. EMITTER, #2 7. BASE, #1 8. EMITTER, #1	STYLE 3: PIN 1. DRAIN, DIE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1	STYLE 4: PIN 1. ANODE 2. ANODE 3. ANODE 4. ANODE 5. ANODE 6. ANODE 7. ANODE 8. COMMON CATHODE
STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN 4. DRAIN 5. GATE 6. GATE 7. SOURCE 8. SOURCE	STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN 4. SOURCE 5. SOURCE 6. GATE 7. GATE 8. SOURCE	STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS 3. THIRD STAGE SOURCE 4. GROUND 5. DRAIN 6. GATE 3 7. SECOND STAGE Vd 8. FIRST STAGE Vd STYLE 11:	STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 3. BASE, #2
STYLE 9: PIN 1. EMITTER, COMMON 2. COLLECTOR, DIE #1 3. COLLECTOR, DIE #2 4. EMITTER, COMMON 5. EMITTER, COMMON 6. BASE, DIE #2 7. BASE, DIE #1 8. EMITTER, COMMON	STYLE 10: PIN 1. GROUND 2. BIAS 1 3. OUTPUT 4. GROUND 5. GROUND 6. BIAS 2 7. INPUT 8. GROUND	PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. DRAIN 2 7. DRAIN 1 8. DRAIN 1	PIN 1. SOURCE 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN
STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. DRAIN 8. DRAIN	STYLE 14: PIN 1. N-SOURCE 2. N-GATE 3. P-SOURCE 4. P-GATE 5. P-DRAIN 6. P-DRAIN 7. N-DRAIN 8. N-DRAIN	STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON	STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 3. EMITTER, DIE #2 4. BASE, DIE #2 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 7. COLLECTOR, DIE #1 8. COLLECTOR, DIE #1
STYLE 17: PIN 1. VCC 2. V2OUT 3. V10UT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC	STYLE 18: PIN 1. ANODE 2. ANODE 3. SOURCE 4. GATE 5. DRAIN 6. DRAIN 7. CATHODE 8. CATHODE	STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2	STYLE 20: PIN 1. SOURCE (N) 2. GATE (N) 3. SOURCE (P) 4. GATE (P) 5. DRAIN 6. DRAIN
5. RXE 6. VEE 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3. CATHODE 3 4. CATHODE 4 5. CATHODE 5 6. COMMON ANODE 7. COMMON ANODE 8. CATHODE 6	8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3. COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND	7. DHAIN 1 8. MIRROR 1 STYLE 23: PIN 1. LINE 1 IN 2. COMMON ANODE/GND 3. COMMON ANODE/GND 4. LINE 2 IN 5. LINE 2 OUT 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT	STYLE 24: PIN 1. BASE 2. EMITTER 3. COLLECTOR/ANODE 4. COLLECTOR/ANODE 5. CATHODE 6. CATHODE 7. COLLECTOR/ANODE 8. COLLECTOR/ANODE
STYLE 25: PIN 1. VIN 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT	STYLE 26: PIN 1. GND 2. dv/dt 3. ENABLE 4. ILIMIT 5. SOURCE 6. SOURCE 7. SOURCE 8. VCC	STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN	STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V_MON 6. VBULK 7. VBULK 8. VIN
STYLE 29: PIN 1. BASE, DIE #1 2. EMITTER, #1 3. BASE, #2 4. EMITTER, #2 5. COLLECTOR, #2 6. COLLECTOR, #2 7. COLLECTOR, #1 8. COLLECTOR, #1	STYLE 30: PIN 1. DRAIN 1 2. DRAIN 1 3. GATE 2 4. SOURCE 2 5. SOURCE 1/DRAIN 2 6. SOURCE 1/DRAIN 2 7. SOURCE 1/DRAIN 2 8. GATE 1		

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